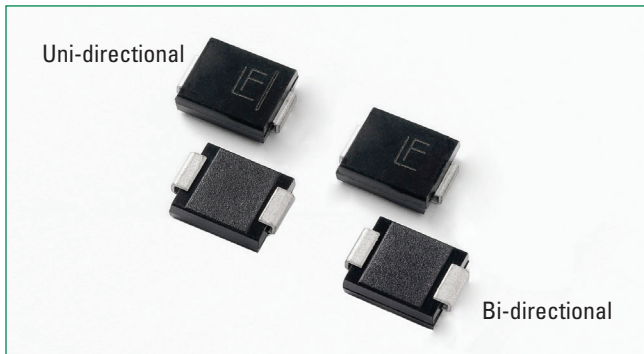


SMDJ Series



Agency Approvals

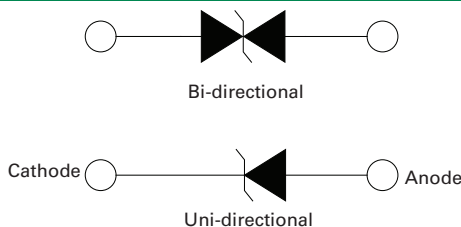
Agency	Agency File Number
	E230531

Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation(Fig.2) by 10/1000us Test Waveform(Fig.4) (Note 1),(Note 2) -Single Die Parts	P _{PPM}	3000	W
Peak Pulse Power Dissipation(Fig.2) by 10/1000us Test Waveform(Fig.4) (Note 1), (Note 2) -Stacked Die Parts (Note 5)	P _{PPM}	4000	W
Power Dissipation on Infinite Heat Sink at T _J =50°C	P _D	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I _{FSM}	300	A
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only(Note 4)	V _F	3.5/5.0	V
Operating Temperature Range	T _J	-65 to 150	°C
Storage Temperature Range	T _{STG}	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	R _{θJL}	15	°C/W
Typical Thermal Resistance Junction to Ambient	R _{θJA}	75	°C/W

- Notes:**
1. Non-repetitive current pulse, per Fig. 4 and derated above T_J (initial) =25°C per Fig. 3.
 2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.
 3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional component only, duty cycle=4 per minute maximum.
 4. V_F < 3.5V for single die parts and V_F < 5.0V for stacked-die parts.
 5. For stacked die component details, please refer to part numbers labeled by * in Electrical Characteristics.

Functional Diagram



Description

The SMDJ series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- 3000W P_{PPM} capability at 10/1000µs waveform, repetition rate (duty cycles):0.01%
- For surface mounted applications in order to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- Glass passivated chip junction
- Fast response time: typically less than 1.0ps from 0V to BV min
- Excellent clamping capability
- Low incremental surge resistance
- Typical I_r less than 2µA when V_{BR} min>12V
- High temperature to reflow soldering guaranteed: 260°C/30sec
- V_{BR} @T_J= V_{BR} @25°C x (1+αT x (T_J - 25)) (αT:Temperature Coefficient, typical value is 0.1%)
- UL Recognized compound meeting flammability rating V-0
- Meet MSL level1, per J-STD-020, LF maximum peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applications

TVS components are ideal for the protection of I/O Interfaces, V_{CC} bus and other vulnerable circuits used in telecom, computer, Industrial and consumer electronic applications.

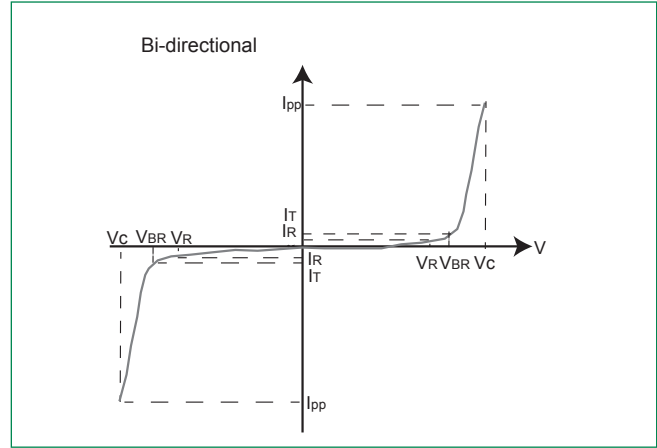
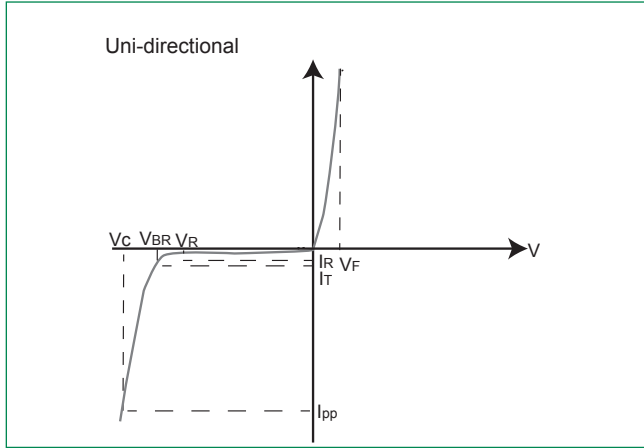
Additional Information


[Datasheet](#)


[Resources](#)


[Samples](#)

I-V Curve Characteristics



- P_{PPM} Peak Pulse Power Dissipation** – Max power dissipation
- V_R Stand-off Voltage** – Maximum voltage that can be applied to the TVS without operation
- V_{BR} Breakdown Voltage** – Maximum voltage that flows thogh the TVS at a specified test current (I_T)
- V_C Clamping Voltage** – Peak voltage measured across the TVS at a specified I_{ppm} (peak impulse current)
- I_R Reverse Leakage Current** – Current measured at V_R
- V_F Forward Voltage Drop for Uni-directional**

Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

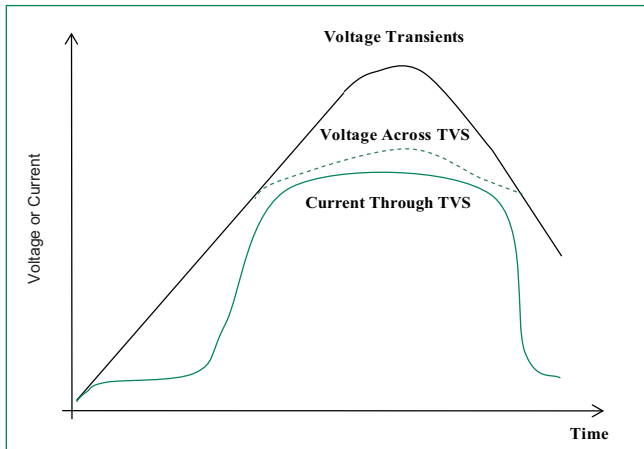
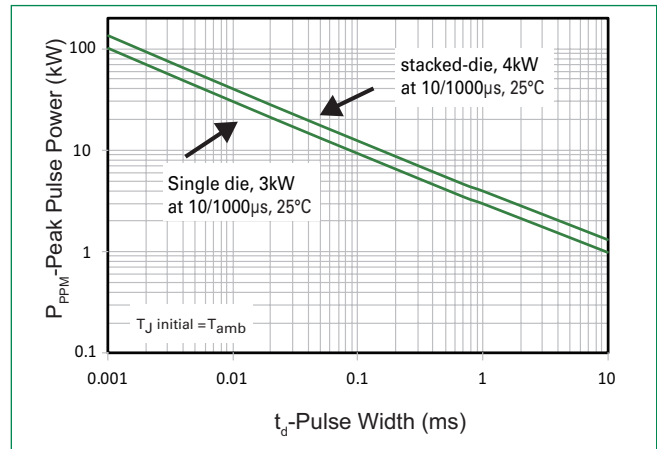


Figure 2 - Peak Pulse Power Rating



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Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted) (Continued)

Figure 3 - Peak Pulse Power Derating Curve

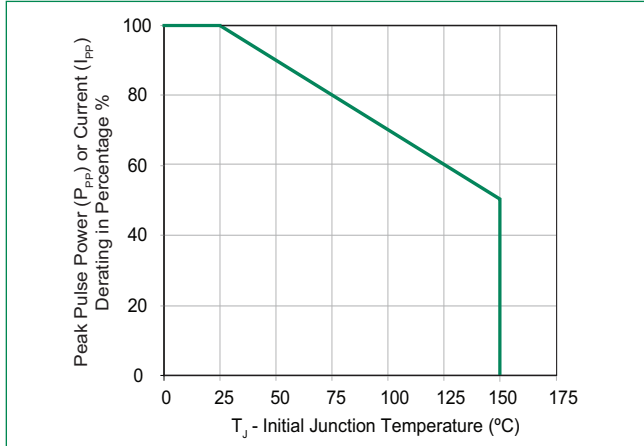


Figure 4 - Pulse Waveform

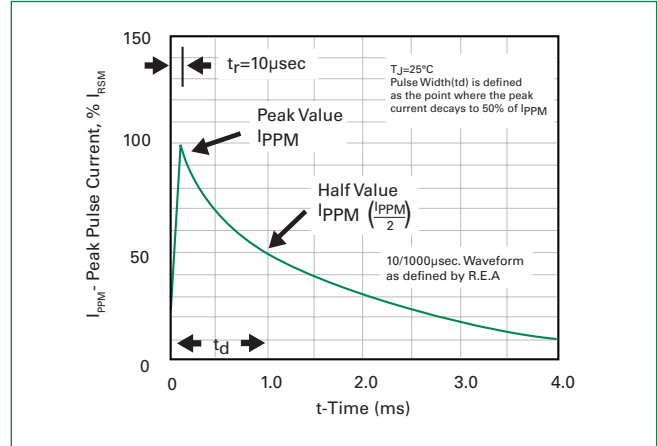


Figure 5 - Typical Junction Capacitance

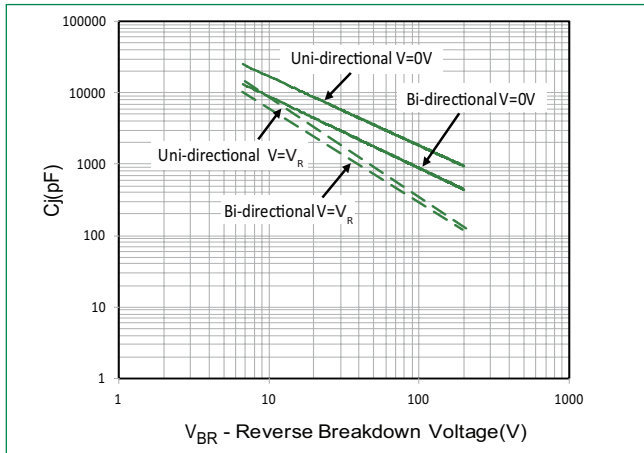


Figure 6 - Typical Transient Thermal Impedance

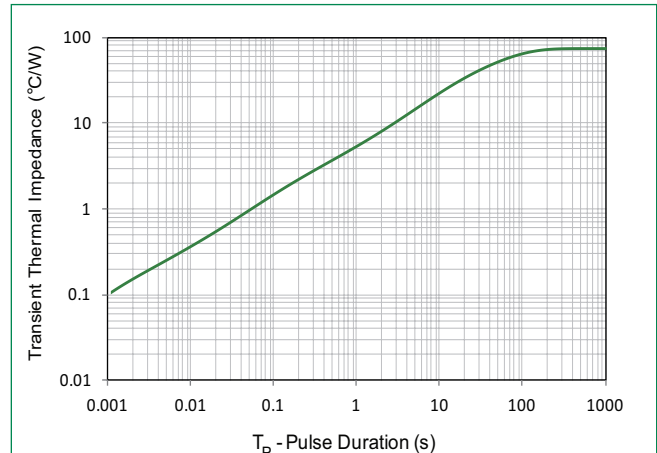


Figure 7 - Maximum Non-Repetitive Peak Forward Surge Current Uni-Directional Only

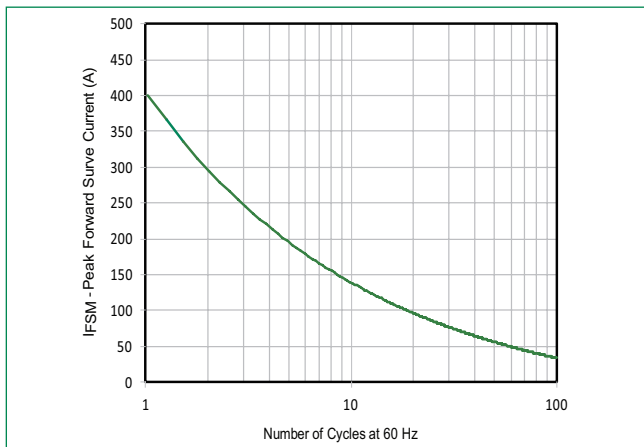
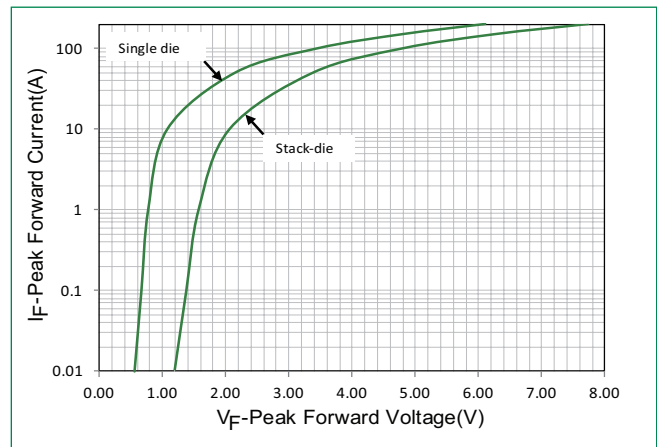
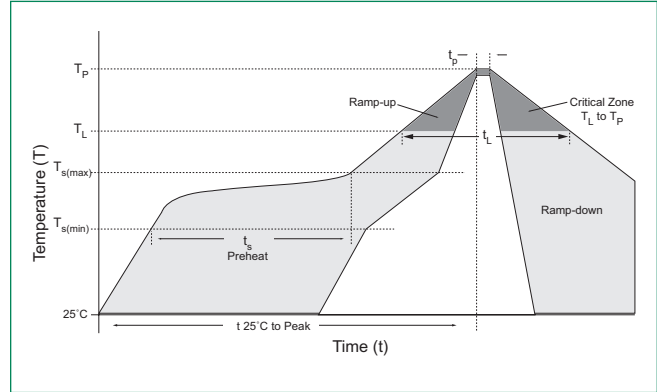


Figure 8 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)



Soldering Parameters

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 120 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Time (min to max) (t_r)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		30 seconds max
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C



Physical Specifications

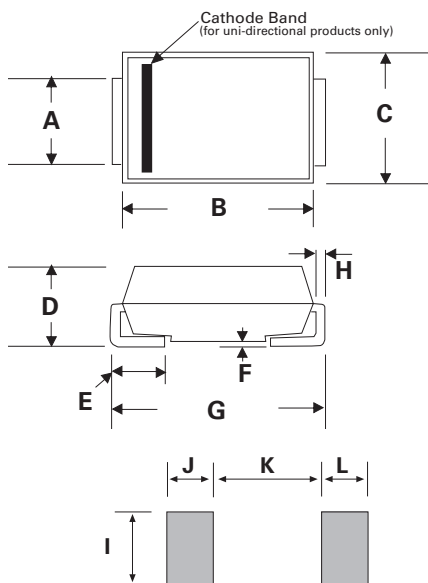
Weight	0.007 ounce, 0.21 grams
Case	JEDEC DQ214AB. Molded plastic body over glass passivated junction
Polarity	Color band denotes positive end (cathode) except for bidirectional versions.
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102

Environmental Specifications

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111

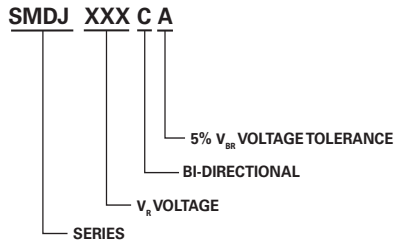
Dimensions

DO-214AB (SMC J-Bend)

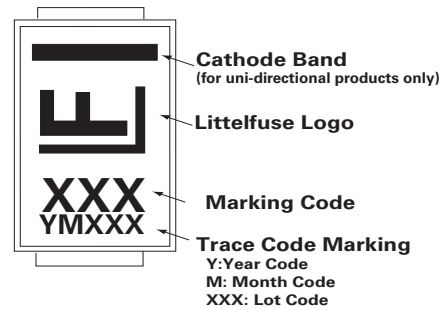


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.114	0.126	2.900	3.200
B	0.260	0.280	6.600	7.110
C	0.220	0.245	5.590	6.220
D	0.079	0.103	2.060	2.620
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.305	0.320	7.750	8.130
H	0.006	0.012	0.152	0.305
I	0.129	-	3.300	-
J	0.094	-	2.400	-
K	-	0.165	-	4.200
L	0.094	-	2.400	-

Part Numbering System



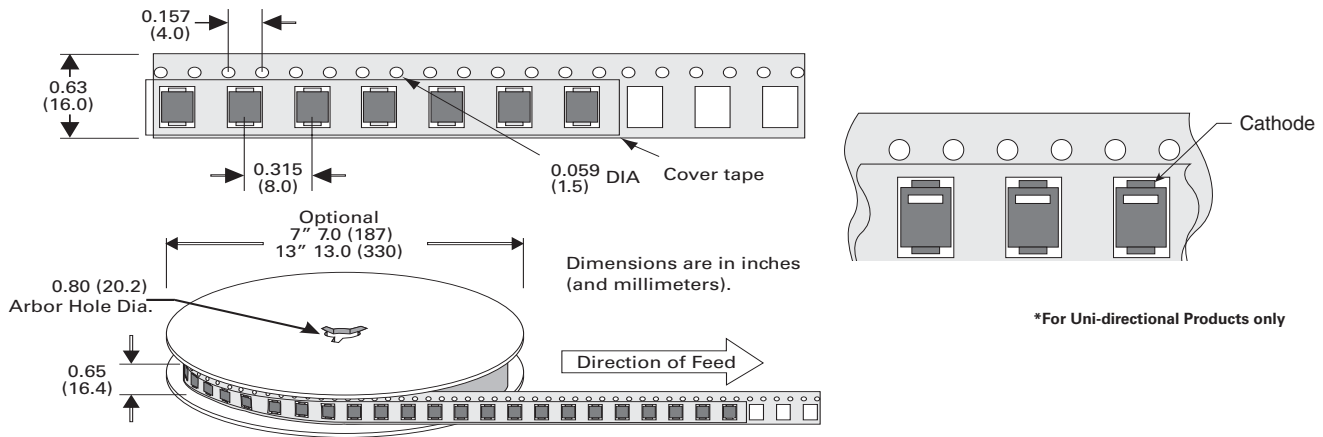
Part Marking System



Packaging Options

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMDJxxxXX	DO-214AB	3000	Tape & Reel - 16mm tape/13" reel	EIA STD RS-481
SMDJxxxXX-T7	DO-214AB	500	Tape & Reel - 16mm tape/7" reel	EIA STD RS-481

Tape and Reel Specification



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